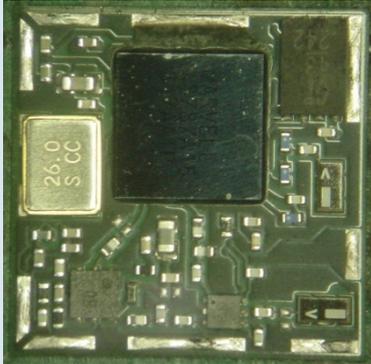
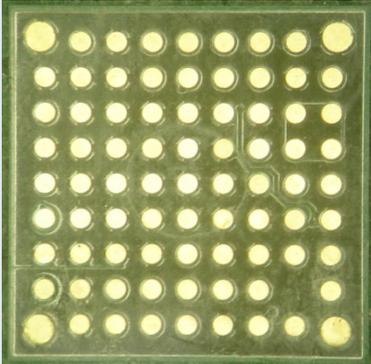
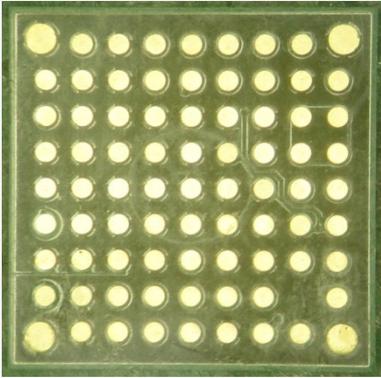


Wireless Module photo (USI)

	Upper side	Bottom side
w/o Shield cover	 The image shows the upper side of a wireless module without a shield cover. It features a green printed circuit board (PCB) with various components. A prominent black square chip is located in the center. To the left of this chip is a smaller, rectangular component with the markings '260' and 'S CC'. The PCB is populated with numerous small surface-mount components and traces.	 The image shows the bottom side of the wireless module without a shield cover. It displays a dense array of gold-colored solder balls arranged in a grid pattern, which are used for surface-mount technology (SMT) or ball grid array (BGA) connections. The underlying green PCB is visible through the grid.
w/ Shield cover	 The image shows the upper side of the wireless module with a shield cover. The shield is a square, gold-colored metal plate that completely covers the underlying components. On the shield, there is a QR code in the upper center, and below it, the alphanumeric string '596359601' and 'USI 140308' are printed in a light color.	 The image shows the bottom side of the wireless module with a shield cover. It displays a dense array of gold-colored solder balls arranged in a grid pattern, similar to the 'w/o Shield cover' view. The shield cover is not visible from this angle.